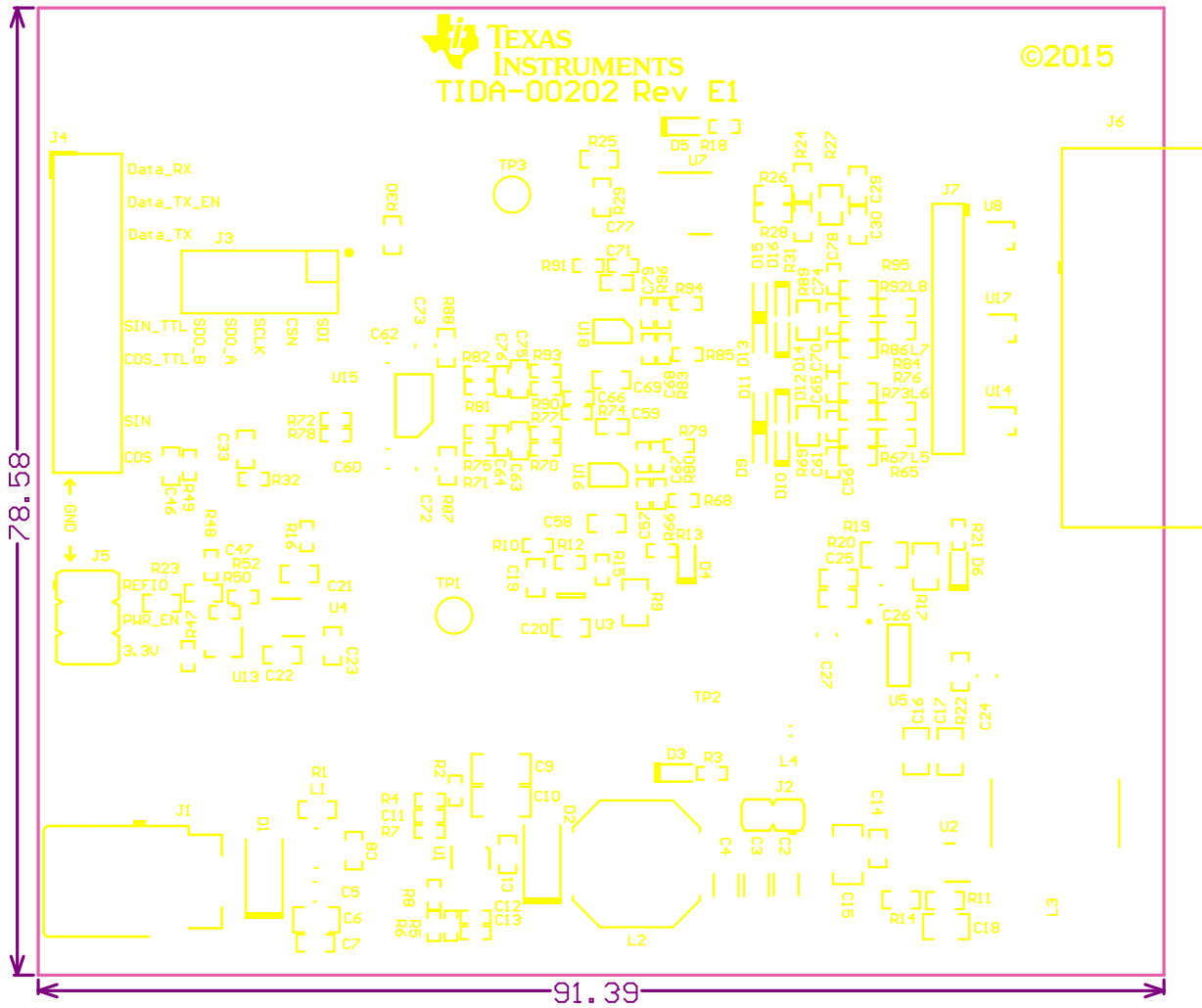
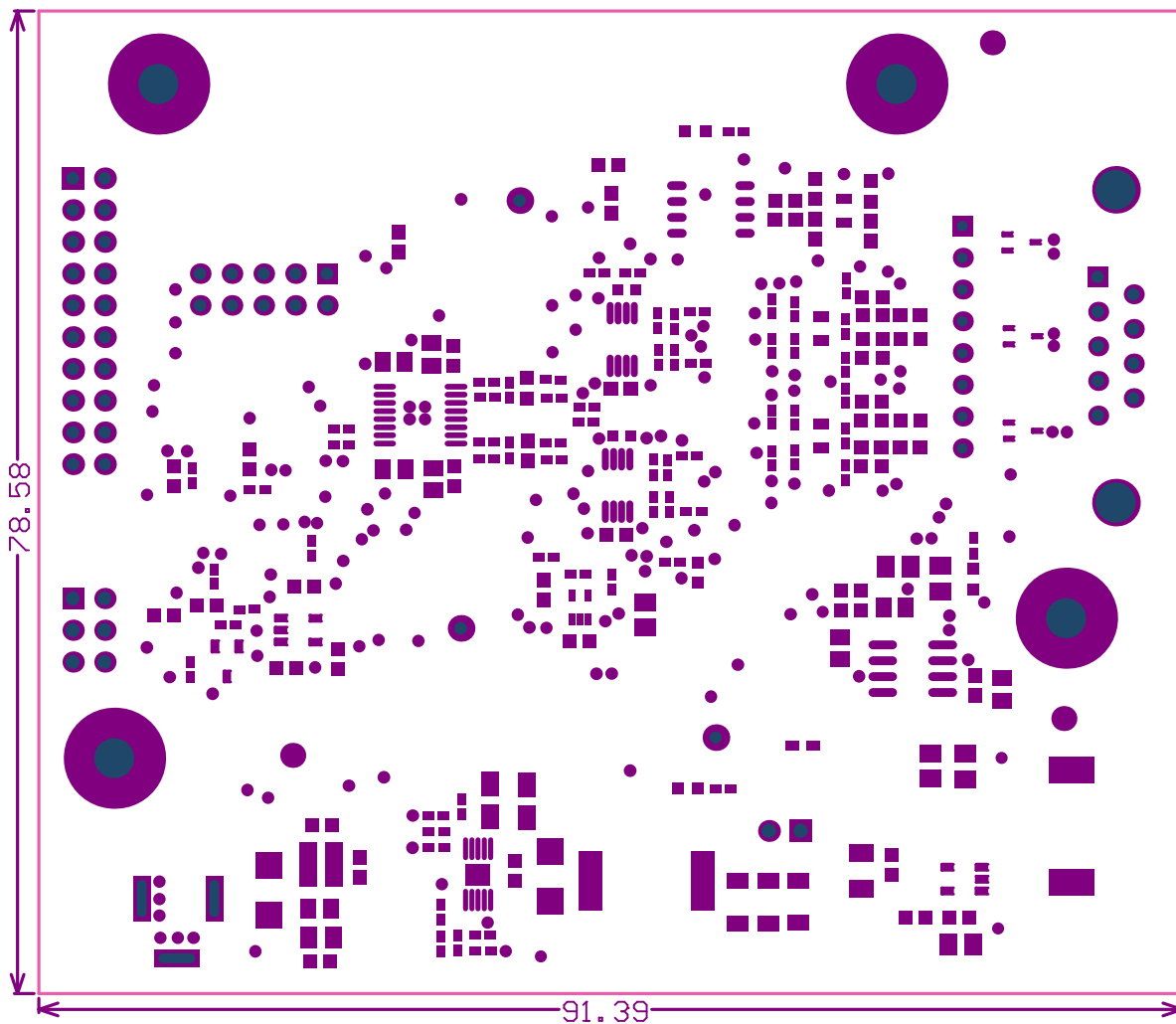



**TEXAS
INSTRUMENTS**
 TIDA-00202 Rev E1

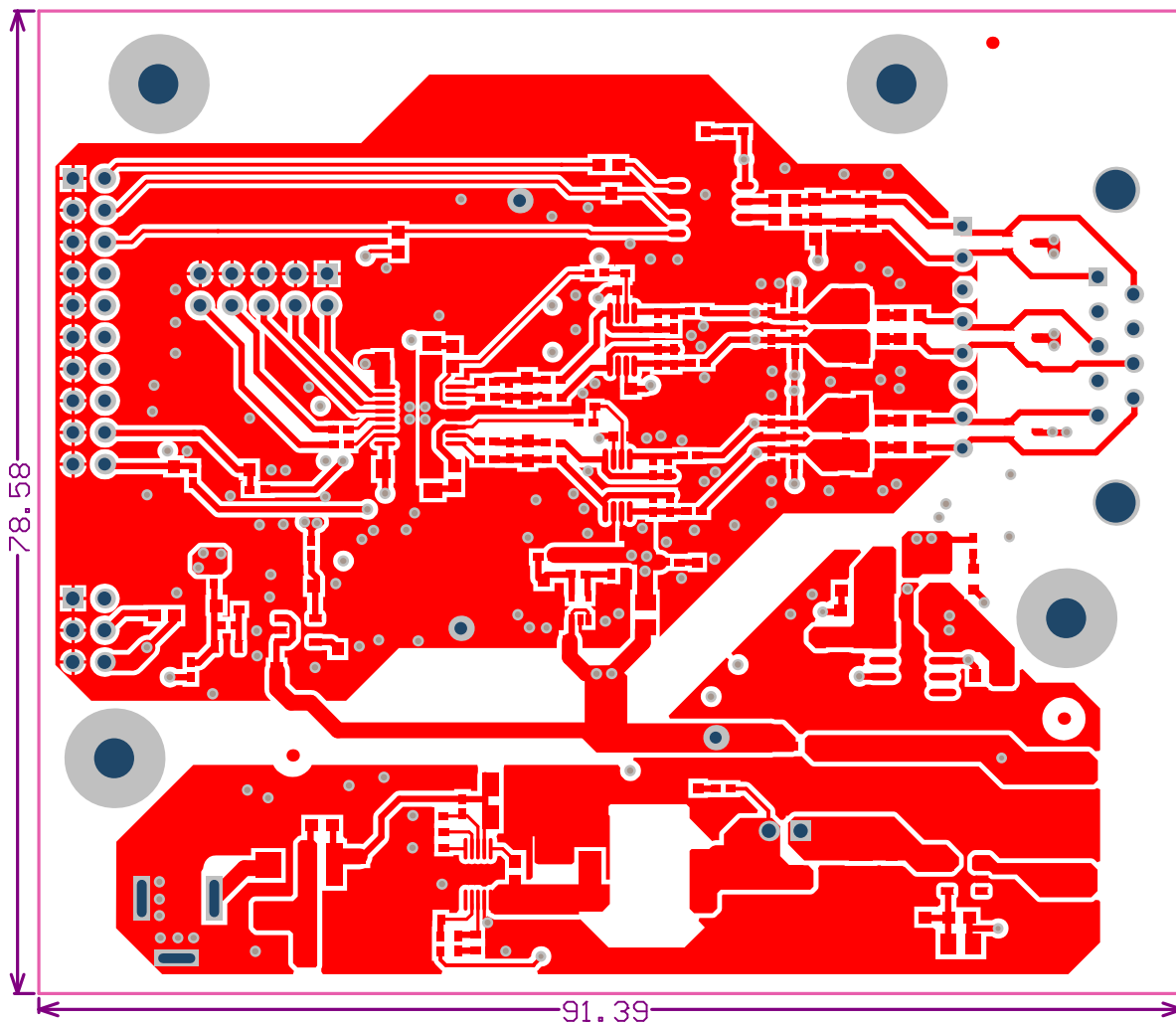
©2015



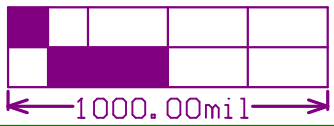
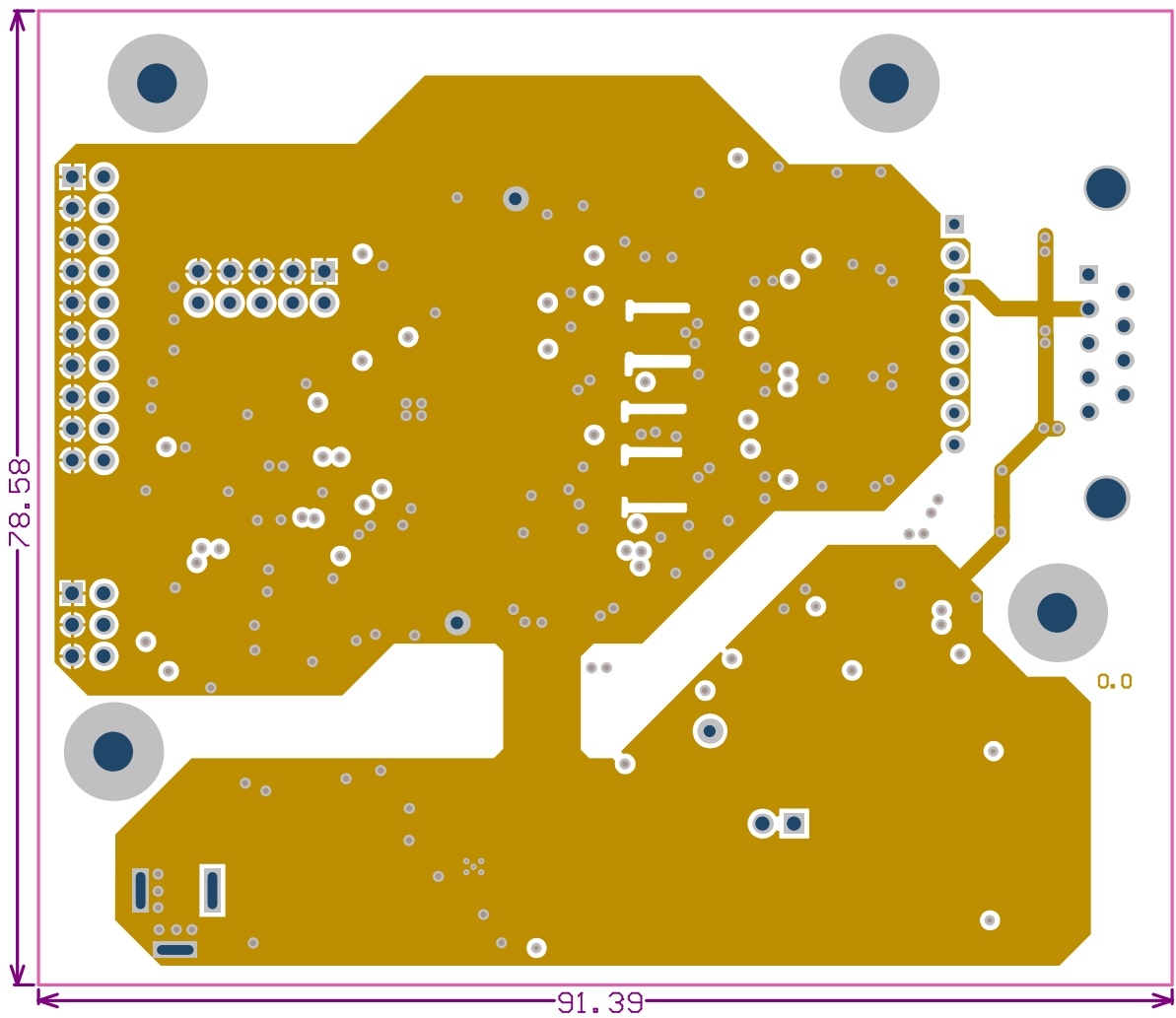
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2pBoard1 Dimensions			
PLOT NAME = Top Overlay	GENERATED : 12/10/2015 1:27:47 PM	TEXAS INSTRUMENTS	



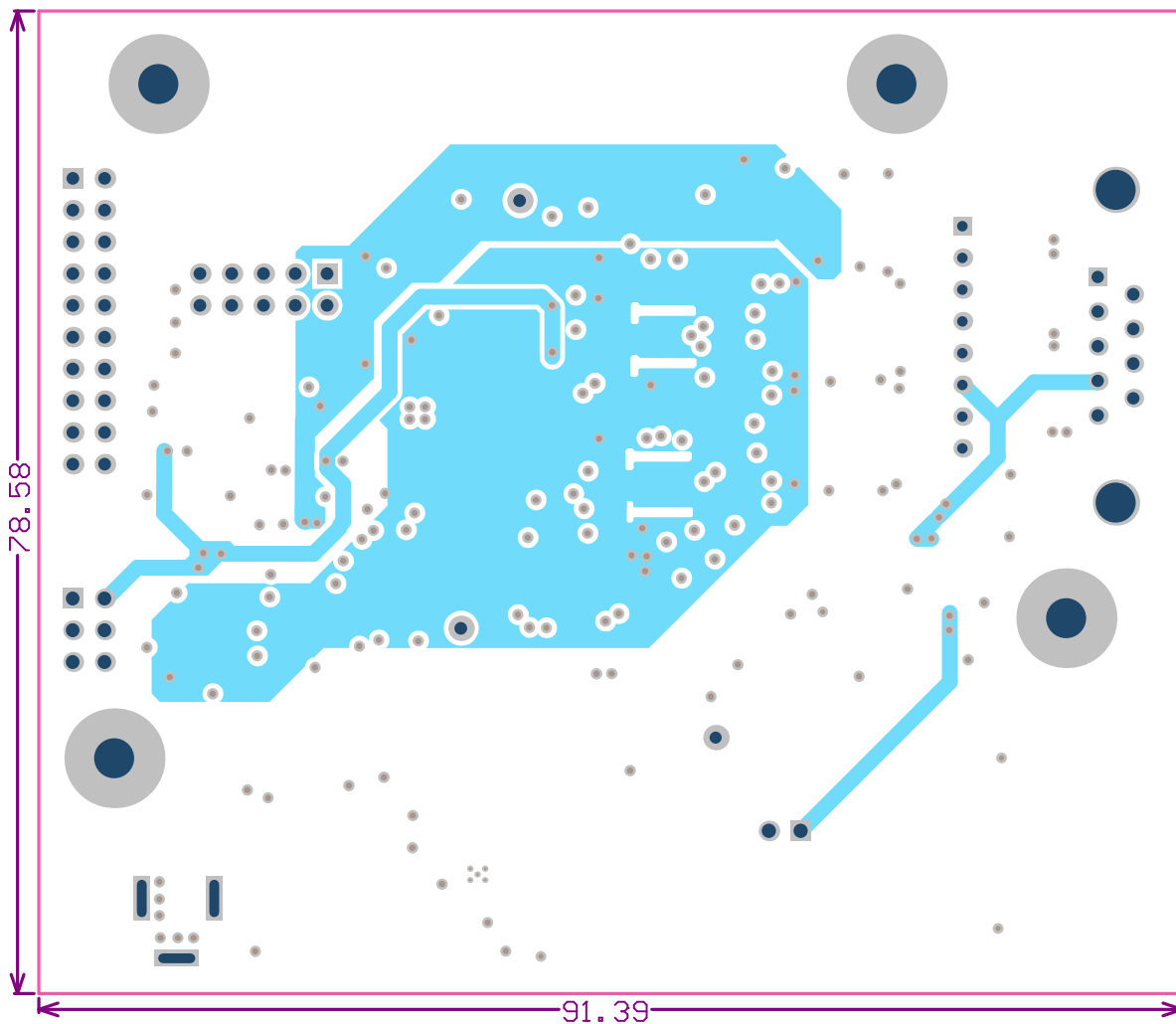
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M@pB@r@d@e@Dimensions			
PLOT NAME = Top Solder Mask	GENERATED : 12/10/2015 1:27:48 PM	TEXAS INSTRUMENTS	



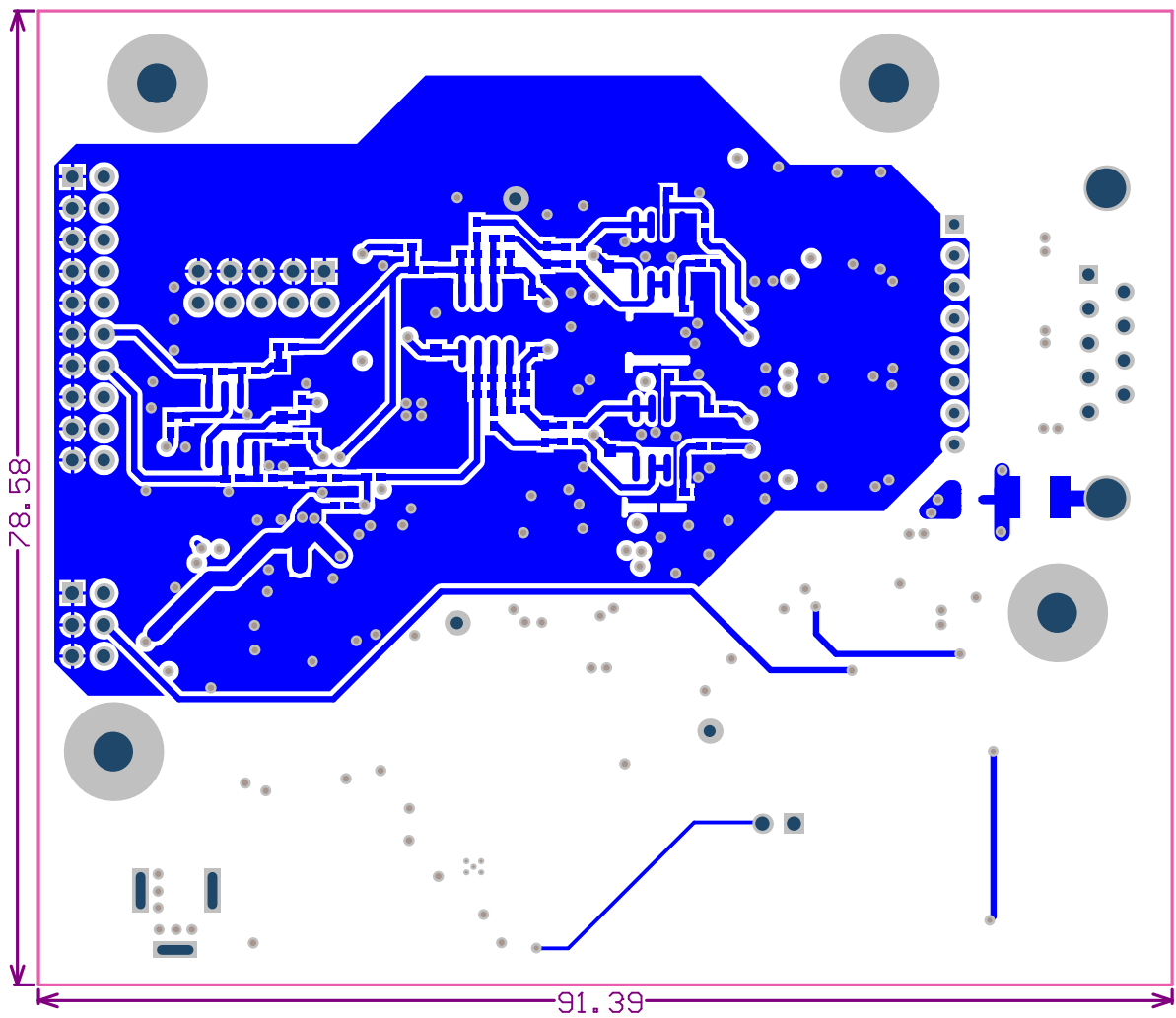
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M@pBbagdrDimensions			
PLOT NAME = Top Layer	GENERATED : 12/10/2015	1:27:50 PM	TEXAS INSTRUMENTS



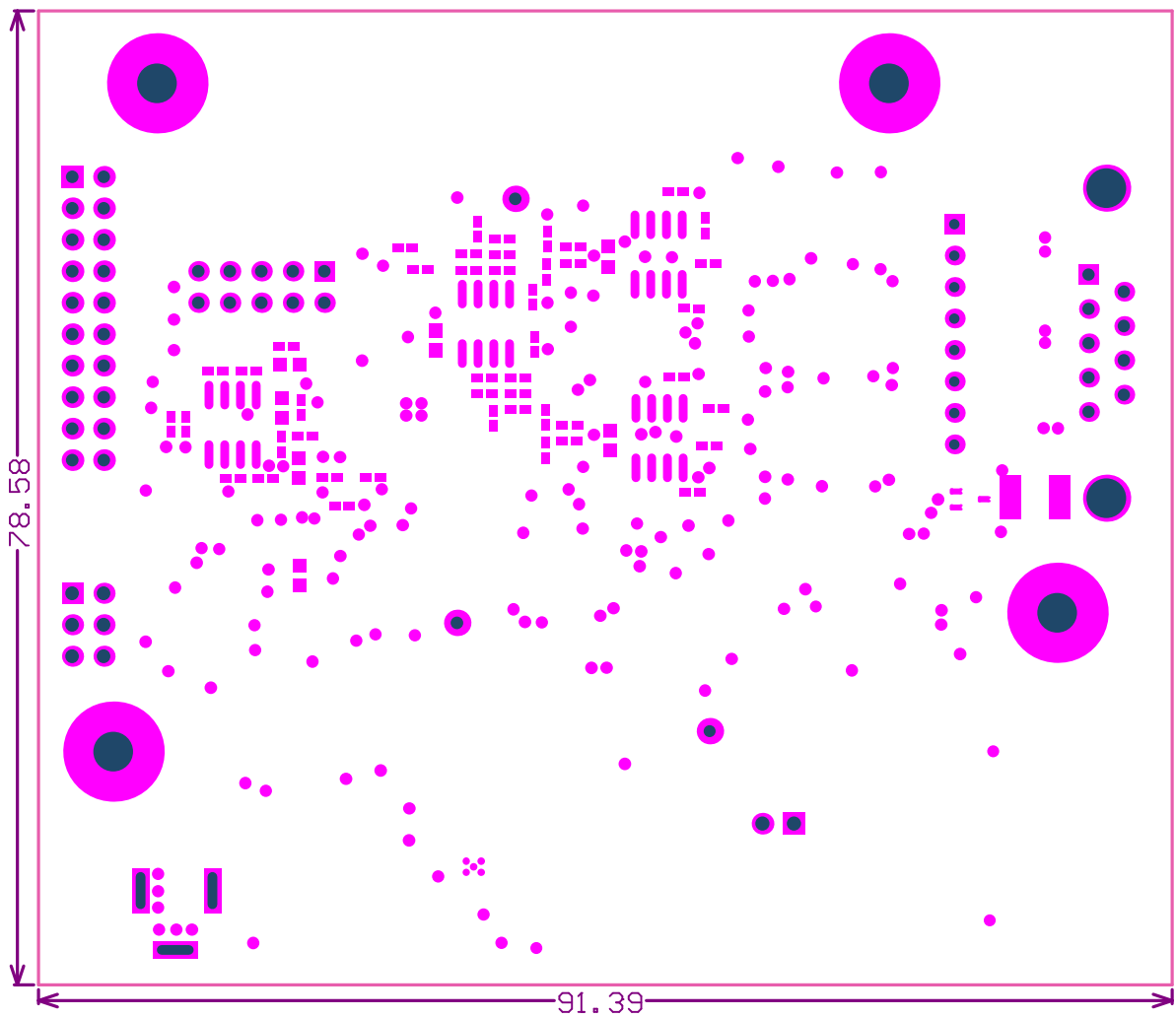
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Mid Layer 1 - GND	GENERATED : 12/10/2015 1:27:51 PM	TEXAS INSTRUMENTS	



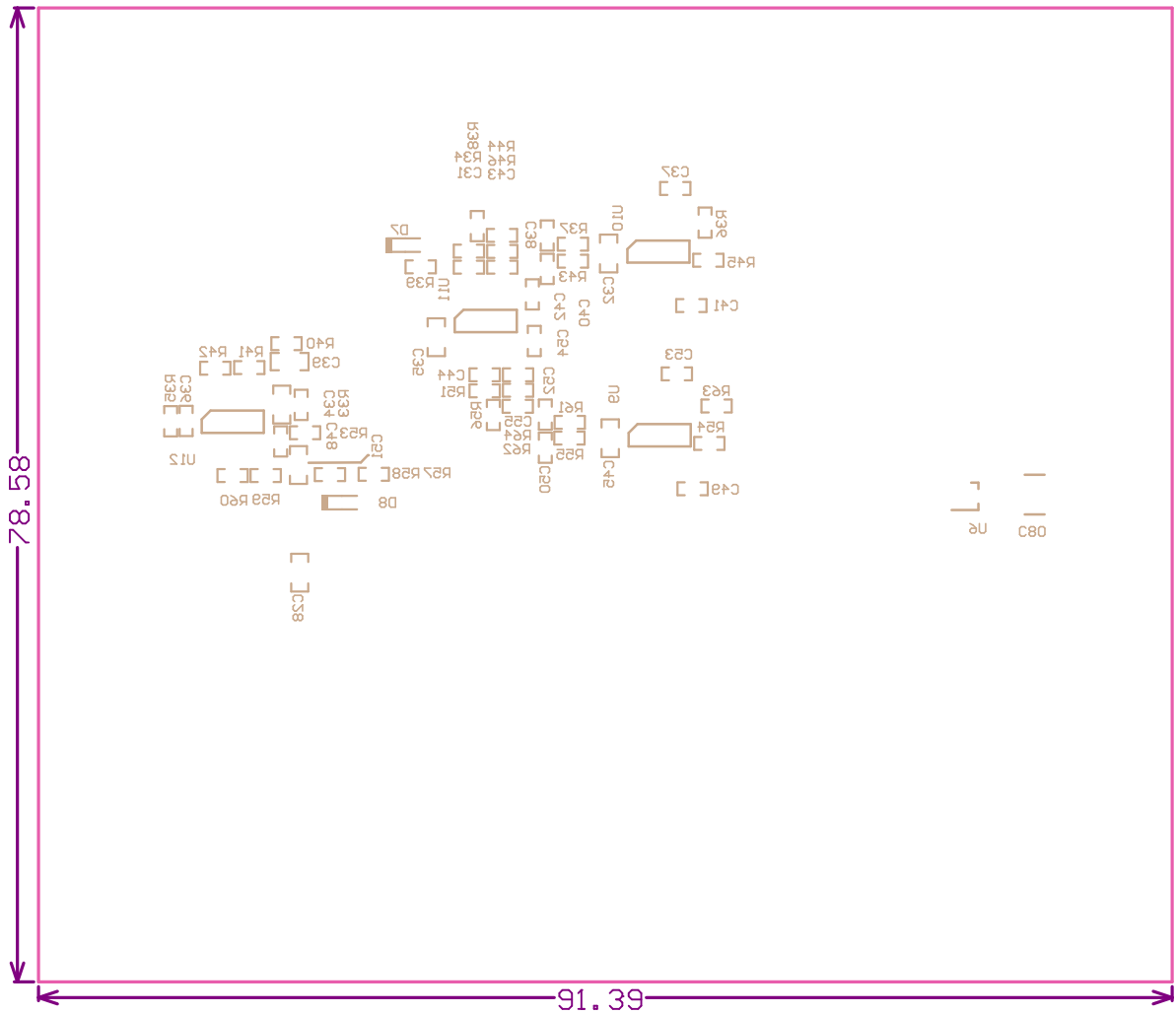
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Mid Layer 2 - VCC	GENERATED : 12/10/2015 1:27:52 PM	TEXAS INSTRUMENTS	



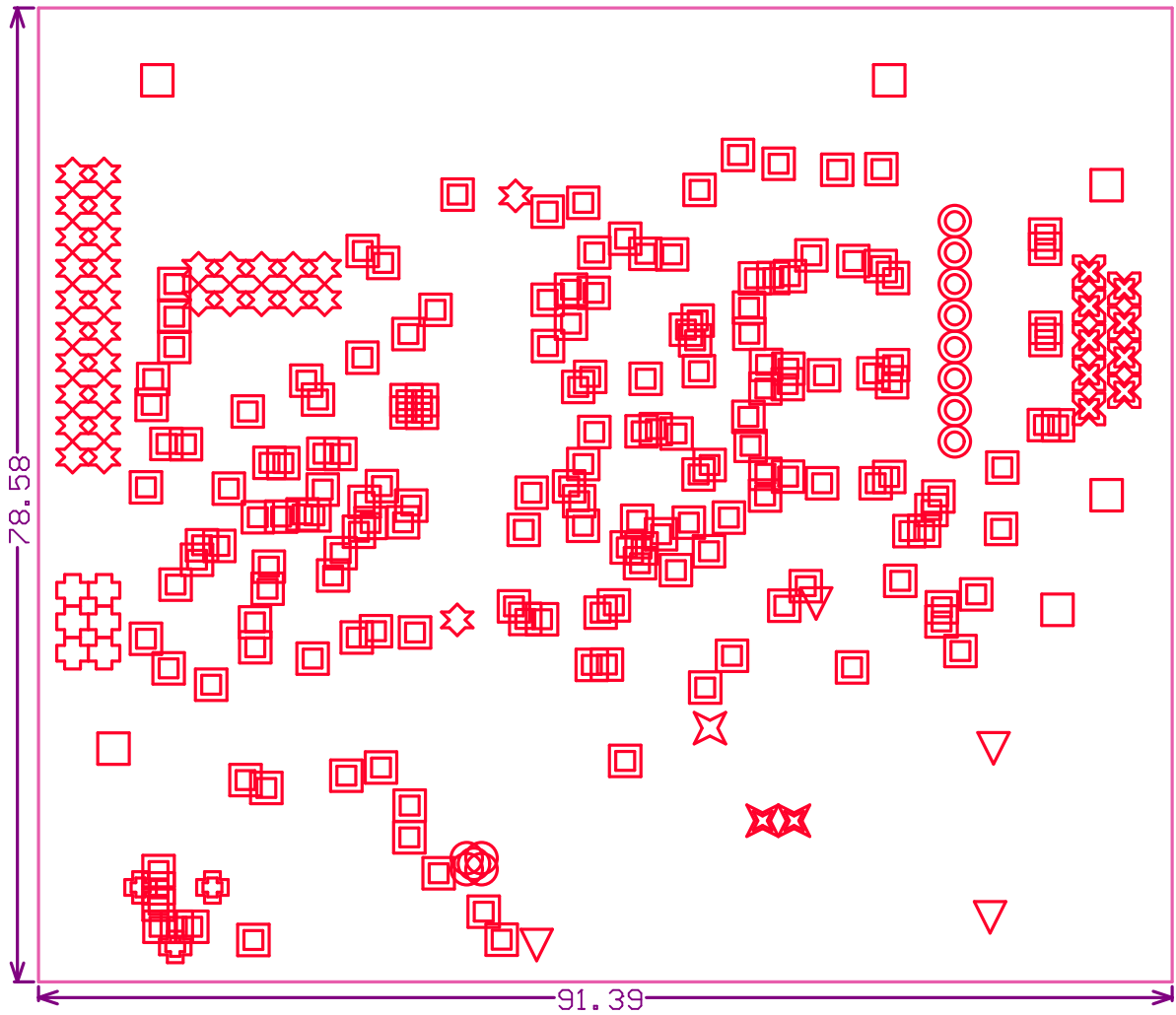
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer Dimensions			
PLOT NAME = Bottom Layer	GENERATED : 12/10/2015 1:27:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2t Board Dimensions			
PLOT NAME = Bottom Solder Mask	GENERATED : 12/10/2015 1:27:56 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Bottom Overlay	GENERATED : 12/10/2015 1:27:57 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plate
○	5	7.87mil (0.200mm)	PTH
▽	4	16.00mil (0.406mm)	PTH
■	169	19.69mil (0.500mm)	PTH
●	8	33.46mil (0.850mm)	PTH
✕	1	37.99mil (0.965mm)	PTH
✖	9	39.37mil (1.000mm)	PTH
☆	32	40.00mil (1.016mm)	PTH
⊕	6	43.31mil (1.100mm)	PTH
✗	2	45.28mil (1.150mm)	PTH
□	6	125.98mil (3.200mm)	PTH
⊗	3	31.50mil (0.800mm)	PTH
245 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Drill Drawing	GENERATED : 12/10/2015 1:27:59 PM	TEXAS INSTRUMENTS	

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